

Entry-level, benchtop, single point selective soldering system





Pilot system with optional PillarGEN Nitrogen generator and fume extraction unit





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PILOT

The all-new ultra-low-cost Pilot machine has been designed as an entry-level, handload, benchtop machine for small to medium batch manufacturers, combining high levels of production flexibility with economic running costs. Offered with two universal, quick change tooling carriers, each one can be exchanged to optimise cycle time. Each carrier is capable of handling a board size up to 330mm x 250mm (13" x 10").

The Pilot incorporates, as standard, our patented Drop-Jet fluxer for quick, accurate flux deposition. An optional bottom side IR pre-heat is also available; this is particularly useful when processing multi-layer PCB's or using water-based flux types.

Although a low-cost system, the Pilot is offered with the ability to run the acclaimed, highly flexible Pillarhouse AP nozzle technology, together with our patented market leading 1.5mm Miro Nozzle. The process is enhanced by a localised hot Nitrogen environment at the point of soldering. An

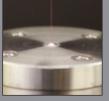
optional Nitrogen generator is built into the base of the unit and can be used to supply Nitrogen at the required levels, whilst acting as a machine stand.

Designed for low maintenance, the Pilot offers a slide in/out solder bath design for ease of access. This, in conjunction with our proven impellor driven pump technology, makes a highly reliable, low maintenance system. By carrying product over the flux, solder and optional pre-heat stations, the Pilot offers a light, highly accurate X, Y system.

Programming is accessed through the world leading Pillarhouse 'Point and Click' PillarCOMMXLITE software package. Optional offline programming is available via PillarPAD, which allows programs to be generated independently from the machine using Gerber data.



JET TIP NOZZL



DROP-JET FLUX HEAD



HANDLOAD QUICK CHANGE TOOLING CARRIER ASSEMBLY





1.5MM MICRO NOZZLE

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OPERATION

The Pilot is controlled by a PC through PillarCOMMXLITE, a Windows® based 'Point & Click' interface with PCB image display, as illustrated above. Additionally, our PillarPAD offline programming system allows the operator to produce programs independently from the machine using Gerber data.



PILLARGEN 30 Nitrogen generator and machine stand option







BOTTOM SIDE IR PRE-HEAT OPTION

STANDARD FEATURES

Integral PC & Machine Mounted TFT Monitor Inerted Nitrogen System Drop-Jet Fluxer Set of AP Solder Nozzle Tips (2.5mm, 3mm, 3.5mm, 4mmm, 5mm, 6mm, 8mm, 10mm, 12mm) Internal Fume Extraction Manual Fiducial Correction System Process Viewing Camera Colour Programming Camera Two Universally Adjustable Tooling Carriers PillarCOMMXLITE Windows® based 'Point & Click' interface PillarPAD Offline Programming System Solder Wave Height Measurement & Correction Lead-Free Compatibility Day-To-Day Service Kit

SYSTEM OPTIONS

Fume Filtration System Micro Nozzle Assembly Multilevel Password Protection System Bottom Side Pre-Heater Combined Nitrogen Generator & Machine Stand



SLIDE IN/OUT SOLDER BATH



ADDITIONAL SYSTEM OPTION - PillarCARE

Pillarhouse's comprehensive after-sale service and process programme, available for all machines



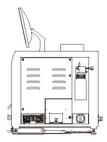


SPECIFICATIONS

PILOT

Height:	With monitor 1050mm/42"
	With cowling 750mm/29" - without 695mm/27"
Width:	With flux bottles 1090mm/43"- without 915mm/36"
	& with solder bath out 1380mm/54"
Depth:	700mm/28" to 963mm/38" with keypad tray out
Weight:	170kg (table-top format)
Board size:	330mm x 250mm/13" x 10"
Edge clearance:	Above/below 3mm
Height clearance:	Above/below 40mm nominal
Solder:	Most commonly used solder types - including lead-free
Solder pot capacity:	6kg
Applicators:	AP style - 2.5mm to 16mm dia.
	Extended AP style - 2.5mm to 20mm dia.
	Micro Nozzle - 1.5mm to 2.5mm
	Jet-Tip style - 6mm to 20mm dia.
	Special dedicated nozzles available upon request
Flux:	Low maintenance Drop-Jet system. Low solids
	(below 8%), no clean flux, pressurised and inerted
	system, optional water-soluble system available
X, Y & Z axis resolution:	0.1mm
Repeatability:	+/- 0.05mm
Nitrogen usage:	30 litres gas/min. 5 bar pressure
Nitrogen purity:	99.99% or better
Power supplies:	Single phase + PE
Voltage:	208V - 250V
Frequency:	50/60Hz
Power:	4kVA including bottom side IR pre-heat
Transport:	Handload
Tooling:	Integral adjustable board guides, includes
	finger extensions and board clamps Windows® based PillarCOMMX Lite 'Point & Click' interface





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